PATENTS ONLY 0 2 0 3

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10-06-2003

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To the Assistant Commissioner of Patents. 102566313

cuments or copy thereof.

3.	(1) Lihui CAO (2) Prasad SUBBARAO (3) David GRADIN (4) Maad AL-DABAGH (5) Weidan LI Additional name(s) of conveying party(ies) attached □ Yes ■ No	* * * * * * * * *	Name: LSI Logic Corporation Street Address: 1621 Barber Lane City: Milpitas State: CA ZIP: 95035 Additional name(s) & address(es) attached? ☐ Yes ■ No		
3.	party(ies) attached □ Yes ■ No	* *			
	Nature of conveyance: Execution				
		dates:	(1) September 15, 2003 (4) September 17, 200 (2) September 21, 2003 (5) September 16 2003		
	 Assignment Correction Document ID No. 102419074 		(3) September 21, 2003		
	Application number(s) or patent number(s):		OFFICE OF ZID3 OCT FINAN		
1	If this document is being filed together with a new appli	cation, t			
,	A. Patent Application No.(s) 10/407,065, filed April 3, 2003	*	B. Patent No.(s)		
i	Additional numbers attached? ☐ Yes ■ No	* A	Additional numbers attached? Yes No		
(Name and address of party to whom correspondence concerning document should be mailed:	* 6. *	Total Number of applications and patents involved: One		
! ,,	Name: Sandeep Jaggi Internal Mail Stop D-106 Address: LSI Logic Corporation Street 1621 Barber Lane	* *	Total fee (37 CFR 3.41)\$ 40.00 ☐ Enclosed ■ Authorized to be charged to Deposit Acct.		
,	Address: Milpitas, California 95035	* 8. * *	Deposit Account Number: 12-2252 LSI Logic Corporation (Attach copy of this page)		
9.	Statement and signature.				
á	To the best of my knowledge and belief, the foregoing attached copy is a true copy of the original document.	nformat \	ion is true and correct and any		
	September 26, 2003 Date	<u>ں</u> Stenh	nen G. Sullivan, Reg. No. 38,329		

PATENT REEL: 014555 FRAME: 0075

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	erdation form cover sheet 04 ints only 4-3-0-3		103 us	Department of Commer Patent & Trademark Offi
To the	e Assistant Commissioner of Patents: Pk. 1	024/190	7.4	or copy thereof.
1.	Name of conveying party(les): (IN COUNTERPAR	r)	Name and addres	s of receiving party(ies):
	(1) Lihui CAO (2) Prasad SUBBARAO (3) David GRADIN (4) Maad AL-DABAGH (5) Weidan Li			Corporation 551 McCarthy Boulevard ate: CA ZIP: 95035
	Additional name(s) of conveying party(ies) attached ☐ Yes ■ No	•	Additional name(s) & address(es) attached? No
3.	Nature of conveyance: Execu	ıtion dates:	(1) March 31, 2003 (2) March 31, 2003	
4.	Application number(s) or patent number(s):	<i>u</i> 07	065	
4.	Application number(s) or patent number(s): If this document is being filed together with a new a March 31, 2003, March 31, 2003		e execution date of	
4.	If this document is being filed together with a new a	pplication, th	e execution date of	
4.	If this document is being filed together with a new a March 31, 2003, March 31, 2003	pplication, the property of th	Be execution date of the same	
4 .	If this document is being filed together with a new a March 31, 2003, March 31, 2003 A. Patent Application No.(s)	application, the April 2, 200	B. Patent No.(s) Iditional numbers att	003.
	If this document is being filed together with a new a March 31, 2003, March 31, 2003, March 31, 2003 A. Patent Application No.(s) Additional numbers attached? Yes No Name and address of party to whom correspondence concerning document should be mailed: Name: Sandeep Jaggi Internal Mail Stop D-106 Address: LSI Logic Corporation	* Ax * Ax * 7	B. Patent No.(s) ditional numbers att Total Number of app involved: One	ached? Yes No
	If this document is being filed together with a new a March 31, 2003, March 31, 2003, March 31, 2003 A. Patent Application No.(s) Additional numbers attached? Yes No Name and address of party to whom correspondence concerning document should be mailed: Name: Sandeep Jaggi Internal Mail Stop D-106	* Ax * Ax * 7	B. Patent No.(s) ditional numbers att Total Number of app involved: One	ached? Yes No lications and patents 11)\$ 40.00 harged to Deposit Acct. umber: 12-2252 ion

Total number of pages including cover sheet, attachments, and documents: 4

PATENT REEL: 014555 FRAME: 0076

Attorney Docket: 030159/2781P

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the undersigned Lihul CAO, Prasad SUBBARAO, David GRADIN, Maad AL-DABAGH, and Weidan LI do hereby sell, assign, and transfer to: LSI Logic Corporation, a corporation of the state of Delaware, having a principal place of business at 1621 Barber Lane, Milpitas, California 95035 ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,

[] which has been executed by the undersigned concurrently herewith,

[X] which was filed on April 3, 2003, and assigned Serial No. 10/407,065,

and is entitled:

DECOUPLING CAPACITANCE ESTIMATION AND INSERTION FLOW FOR ASIC DESIGNS

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said Unites States application; and

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Signed:

Name: Lihui CAO	Date:9-/5-2003
Name: Prasad SUBBARAO	Date:
Name:	Date:
Name: Maad AL-DABAGH	Date: 9/17/2003
Name: Weidan LI Witnessed by	Date: 9-16-2003 v: Dave 2-10-2003

PATENT

REEL: 014555 FRAME: 0077

Attorney Docket: 030159/2781P

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the undersigned Llhui CAO, Prasad SUBBARAO, David GRADIN, Maad AL-DABAGH, and Weidan LI do hereby sell, assign, and transfer to: LSI Logic Corporation, a corporation of the state of Delaware, having a principal place of business at 1621 Barber Lane, Milpitas, California 95035 ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,

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Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Signed:

Name:		Date:
Name: Prasad SUBBARAO	ر المحال	Date: 9/2/03
Name:		Date:
David GRADIN		
Name:		Date:
Maad AL-DABAGH		
Name:		Date:
Weldan LI	Witnessed by:	

PATENT REEL: 014555 FRAME: 0078

Attorney Docket: 030159/2781P

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the undersigned Lihui CAO, Prasad SUBBARAO, David GRADIN, Maad AL-DABAGH, and Weldan LI do hereby sell, assign, and transfer to: LSI Logic Corporation, a corporation of the state of Delaware, having a principal place of business at 1621 Barber Lane, Milpitas, California 95035 ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,

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Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Signed:

Name:	Date:
Lihui CAO	
Name:	Date:
Prasad SUBBARAO	
Name: David The	Date: 9/21/63
David GRADIN	• •
Name:	Date:
Maad AL-DABAGH	
Name:	Date:
Weidan LI	Witnessed by: Brandac, Frader 9-21-03

PATENT
RECORDED: 04/03/2003 REEL: 014555 FRAME: 0079